



**MMST2907A** 

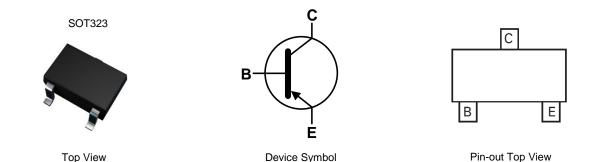
# 60V PNP SMALL SIGNAL TRANSISTOR IN SOT323

## **Features**

- $BV_{CEO} > -60V$
- I<sub>C</sub> = -600mA Collector Current
- **Epitaxial Planar Die Construction**
- Ultra-Small Surface Mount Package
- Complementary NPN Type: MMST2222A
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP Capable (Note 4)

### **Mechanical Data**

- Case: SOT323
- Case Material: Molded Plastic. "Green" Molding Compound. UL Flammability Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Plated Leads. Solderable per MIL-STD-202, Method 208 03
- Weight: 0.006 grams (Approximate)



### Ordering Information (Notes 4 & 5)

Product	Status	Compliance	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel	
MMST2907A-7-F	NRND	AEC-Q101	K3F	7	8	3,000	
MMST2907A-7	Active	AEC-Q101	K3F	7	8	3,000	
MMST2907AQ-7 Active Automotive K3F 7 8 3,000							
Notes: 1. No purpos	Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.						

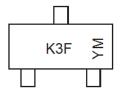
2. See http://www.diodes.com/quality/lead free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. Automotive products are AEC-Q101 qualified and are PPAP capable. Automotive, AEC-Q101 and standard products are electrically and thermally the same, except where specified. For more information, please refer to http://www.diodes.com/quality/product\_compliance\_definitions/.

5. NRND = Not Recommended for New Design. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

## **Marking Information**



K3F = Product Type Marking Code YM = Date Code Marking Y or  $\overline{Y}$  = Year (ex: A = 2013) M or  $\overline{M}$  = Month (ex: 9 = September)

Date Code Key

2010 0000													
Year	2010	2	011	2012	2013	2014	2015	201	6 20	17 2	2018	2019	2020
Code	Х		Y	Z	А	В	С	D	I	Ξ	F	G	Н
Mont	h	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	)	1	2	3	4	5	6	7	8	9	0	N	D



## Absolute Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V <sub>CBO</sub>	-60	V
Collector-Emitter Voltage	V <sub>CEO</sub>	-60	V
Emitter-Base Voltage	V <sub>EBO</sub>	-5	V
Collector Current	Ι <sub>C</sub>	-600	mA

# Thermal Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 6)	PD	200	mW
Thermal Resistance, Junction to Ambient (Note 6)	R <sub>0JA</sub>	625	°C/W
Operating and Storage Temperature Range	TJ, T <sub>STG</sub>	-55 to +150	°C

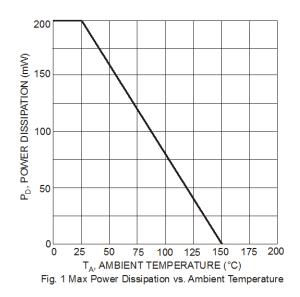
### ESD Ratings (Note 7)

Characteristic	Symbol	Value	Unit	JEDEC Class
Electrostatic Discharge - Human Body Model	ESD HBM	4,000	V	ЗA
Electrostatic Discharge - Machine Model	ESD MM	400	V	С

Notes: 6. For a device mounted with the collector lead on minimum recommended pad layout 1oz copper that is on a single-sided 1.6mm FR4 PCB; device is measured under still air conditions whilst operating in a steady-state.

7. Refer to JEDEC specification JESD22-A114 and JESD22-A115.

# Thermal Characteristics and Derating Information





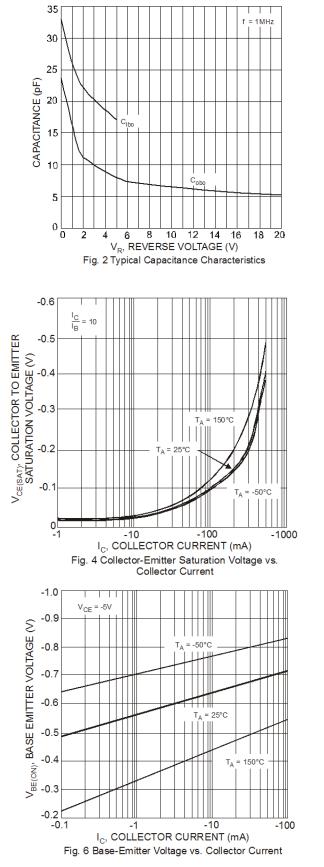
# Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Мах	Unit	Test Condition
OFF CHARACTERISTICS (Note 8)	Symbol	IVIIII	IVIAX	Unit	Test condition
Collector-Base Breakdown Voltage	BV <sub>CBO</sub>	-60		V	$I_{\rm C} = -10\mu A$ , $I_{\rm E} = 0$
Collector-Emitter Breakdown Voltage	BVCEO	-60	_	V	$I_{\rm C} = -10 \text{mA}, I_{\rm B} = 0$
Emitter-Base Breakdown Voltage	BVEBO	-5	_	V	$I_E = -10\mu A, I_C = 0$
Collector Base Cutoff Current	Ісво		-10	nA μA	$V_{CB} = -50V, I_E = 0$ $V_{CB} = -50V, I_E = 0, T_A = +125^{\circ}C$
Collector Cutoff Current	ICEX		-50	nA	$V_{CE} = -30V, V_{EB(OF F)} = -0.5V$
Base Cutoff Current	I <sub>BL</sub>		-50	nA	$V_{CE} = -30V, V_{EB(OFF)} = -0.5V$
ON CHARACTERISTICS (Note 8)					
DC Current Gain	hfe	75 100 100 100 50	  300 	_	$\begin{split} I_{C} &= -100 \mu A, \ V_{CE} &= -10V \\ I_{C} &= -1mA, \ V_{CE} &= -10V \\ I_{C} &= -10mA, \ V_{CE} &= -10V \\ I_{C} &= -150mA, \ V_{CE} &= -10V \\ I_{C} &= -500mA, \ V_{CE} &= -10V \end{split}$
Collector-Emitter Saturation Voltage	V <sub>CE(sat)</sub>	_	-0.4 -1.6	V	$I_{C} = -150mA$ , $I_{B} = -15mA$ $I_{C} = -500mA$ , $I_{B} = -50mA$
Base-Emitter Saturation Voltage	V <sub>BE(sat)</sub>	_	1.3 2.6	V	$I_{C} = -150$ mA, $I_{B} = -15$ mA $I_{C} = -500$ mA, $I_{B} = -50$ mA
SMALL SIGNAL CHARACTERISTICS					• •
Output Capacitance	Cobo		8	pF	$V_{CB} = -10V, f = 1.0MHz, I_E = 0$
Input Capacitance	C <sub>ibo</sub>		30	pF	$V_{EB} = -2V$ , f = 1.0MHz, I <sub>C</sub> = 0
Current Gain-Bandwidth Product	f⊤	200	_	MHz	$V_{CE} = -20V, I_C = -50mA,$ f = 100MHz
SWITCHING CHARACTERISTICS					·
Turn-On Time	t <sub>on</sub>	_	45	ns	$V_{CC} = -30V, I_{C} = -150mA,$
Delay Time	t <sub>d</sub>	_	10	ns	$V_{CC} = -30V, I_C = -150MA,$ $I_{B1} = -15mA$
Rise Time	tr	_	40	ns	
Turn-Off Time	t <sub>off</sub>	_	100	ns	$V_{00} = 6 V_{10} = 150 m \Lambda$
Storage Time	ts	_	80	ns	V <sub>CC</sub> = -6V, I <sub>C</sub> = -150mA, I <sub>B1</sub> = I <sub>B2</sub> = -15mA
Fall Time	t <sub>f</sub>		30	ns	$_{1B1}{1B2} = -131174$

Note: 8. Measured under pulsed conditions. Pulse width  $\leq$  300µs. Duty cycle  $\leq$  2%.



# Typical Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)



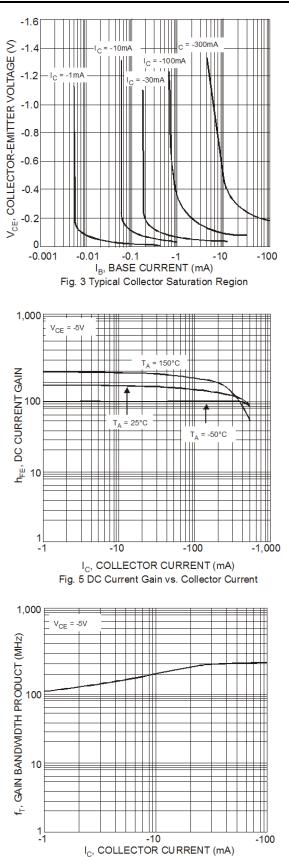
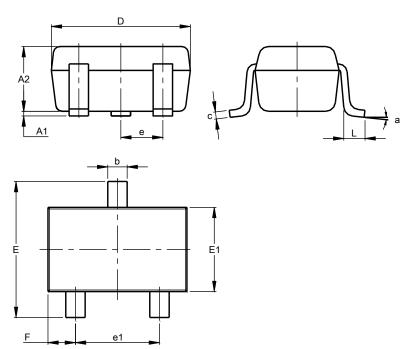


Fig. 7 Gain Bandwidth Product vs. Collector Current



# Package Outline Dimensions

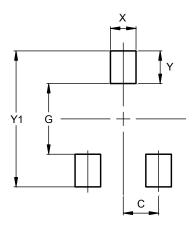
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



	SOT323							
Dim	Min	Min Max Typ						
A1	0.00	0.10	0.05					
A2	0.90	1.00	0.95					
b	0.25	0.40	0.30					
С	0.10	0.18	0.11					
D	1.80	2.20	2.15					
Е	2.00	2.20	2.10					
E1	1.15	1.30						
е	C	).650 B	SC					
e1	1.20	1.40	1.30					
F	0.375	0.475	0.425					
L	0.25	0.40	0.30					
а	8°							
All Dimensions in mm								

# **Suggested Pad Layout**

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
С	0.650
G	1.300
Х	0.470
Y	0.600
Y1	2.500



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